

AMENDMENT TO CLAIMS

1. (Original) A process for sealing a first coolant plate of an electrochemical cell with an adjacent plate, wherein the first coolant plate comprises at least one mating region for mating with a complementary region on the adjacent plate, wherein the adjacent plate is a second coolant plate or a bipolar plate of the electrochemical cell, and the first coolant plate and the adjacent plate each comprise a polymer and conductive filler, said process comprises the step of welding said mating region to said complementary region to create a seal formed by the polymer at the mating region and the complementary region.
2. (Original) The process of claim 1, wherein the welding step is selected from the group consisting of resistance welding, vibrational welding, ultrasonic welding, laser welding, heat lamination, and hot bonding techniques.
3. (Original) The process of claim 2, wherein the welding step is resistance welding.
4. (Original) The process of claim 3, wherein the resistance welding step comprises the further steps of:
 - (a) placing the mating region and complementary region in close proximity to each other;
 - (b) applying an electrical current between the first coolant plate and the adjacent plate to produce localized heat at the mating region and complementary region sufficient to melt the polymer at the mating region and complementary region; and
 - (c) ceasing to apply the current and applying pressure to the first coolant plate and the adjacent plate to allow the melted polymer to cool and to create a seal at the mating region and complementary region.

Claims 5 – 26. (Cancelled)

27. (Previously Presented) The process of claim 4, wherein the electrical current is between about 0.1 amperes/mm² and about 5 amperes/mm², its voltage is between

about 5 and about 25 volts and the current is applied for a time from about 0.1 to about 100 seconds.

28. (Previously Presented) The process of claim 27 wherein the electrical current is between about 0.8 and about 1.1 amperes/mm².
29. (Previously Presented) The process of claim 4 wherein the pressure applied is between about 1 and about 1000 psig.
30. (Previously Presented) The process of claim 29 wherein the pressure applied is between 100 psig and 300 psig.
31. (Previously Presented) The process of claim 4 wherein the electrical current is applied using external electrodes or the plates themselves.
32. (Previously Presented) The process of claim 2, wherein the welding step is vibration welding.
33. (Previously Presented) The process of claim 32, wherein the vibration welding step comprises the further steps of:
 - (a) placing the mating region and complementary region in close proximity to each other;
 - (b) applying a vibrational force between the first coolant plate and the adjacent plate to produce localized heat at the mating region and complementary region sufficient to melt the polymer at the mating region and complementary region; and
 - (c) ceasing to apply the vibrational force and applying pressure to the first coolant plate and the adjacent plate to allow the melted polymer to cool and to create a seal at the mating region and complementary region.
34. (Previously Presented) The process of claim 33, wherein the vibrational force is applied at a frequency of between about 100 and about 500 cycles per second for a time from about 3 to about 100 seconds at an amplitude of between about 0.5 and about 5 mm.

35. (Previously Presented) The process of claim 33, wherein the pressure applied is between about 1 and about 1000 psig.
36. (Previously Presented) The process of claim 35 wherein the pressure is applied between 100 psig and 300 psig.
37. (Previously Presented) The process of claim 1, wherein the polymer is a thermoplastic polymer selected from the group consisting of melt processible polymers, partially fluorinated polymers, thermoplastic elastomers, liquid crystalline polymers, polyolefins, polyamides, aromatic condensation polymers, liquid crystalline polymers and mixtures thereof.
38. (Currently Amended) The process of claim 37, wherein the thermoplastic polymer is a blend of about 1 wt% to about 30 wt% of maleic anhydride modified polymers with the thermoplastic polymer, partially fluorinated polymers and liquid crystalline polymer or mixtures thereof.
39. (Previously Presented) The process of claim 1, wherein the conductive filler is graphite fiber or graphite powder.
40. (Previously Presented) The process of claim 1, wherein the mating region comprises a first rib and the complementary region comprises a second rib or a groove.
41. (Previously Presented) The process of claim 40, wherein at least one of the first coolant plate and the adjacent plate comprise a polymer rich outer layer on either the mating region, the complementary region or both.
42. (Previously Presented) The process of claim 41, wherein the polymer rich outer layer comprises between about 25 wt% and about 100 wt% polymer.
43. (Previously Presented) The process of claim 42, wherein the polymer rich outer layer comprises between about 50 wt% and about 100 wt% polymer.
44. (Previously Presented) The process of claim 1, wherein the mating region and the complementary region are located adjacent to the periphery of the first coolant plate and the adjacent plate.

45. (Previously Presented) The process of claim 1, wherein the first coolant plate and the adjacent plate each comprise at least one manifold hole and the mating region and the complementary region are at the periphery of the manifold holes.
46. (Previously Presented) The process of claim 1, wherein the first coolant plate and the adjacent plate each comprise at least one flow field channel.
47. (Withdrawn) An electrochemical cell component comprising a first coolant plate sealed to an adjacent plate using the process of claim 1.
48. (Withdrawn) An electrochemical cell comprising a first coolant plate and an adjacent plate, wherein the first coolant plate is sealed to the adjacent plate using the process of claim 1.
49. (Withdrawn) An electrochemical cell comprising the fuel cell component of claim 47.
50. (Withdrawn) An electrochemical cell stack comprising a plurality of the electrochemical cells of claim 48.
51. (Withdrawn) The cell component of claim 47, wherein the cell component has a contact resistance less than the contact resistance of two plates that are not joined together.
52. (Withdrawn) The cell component of claim 47, wherein the cell component has a contact resistance that is independent of compression pressure applied to the cell component.